



SFENG 1984 ())



品名	SF33-6-23-60A
MOQ	100
包装	纸箱包装





1. 24
2. OEM
- 3.
- 4.



- 1.PCB[ICT]FCT
2. 2
3. BGA
- 4.QZVZLM
- 5.
- 6.
- 7.30# OKPOM





1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



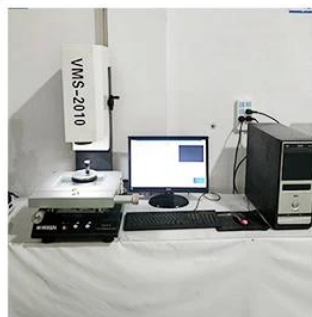
5. Finished products



6. Packing



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test

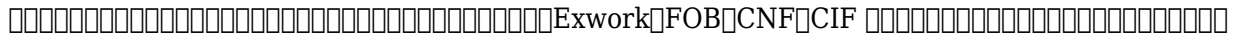
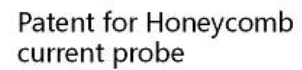
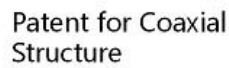


5. Life Fatigue Test



6. Microscope





[illegible][illegible]

A3:

A4:

A5:

Q6.

A6:

Q7.OEM ODM

A7: OEM/ODM

Q8.

A8: T/T□L/C □□□□□□□□□□□□□□□□□□□□ MOQ □□□□□□□ L/C □□□□□□□□